HALOGEN

FREE





Thick Film Chip Resistors, High Voltage



FEATURES

- High voltage up to 3000 V
- Outstanding stability < 0.5 %
- Flow solderable
- Custom sizes available
- · Automatic placement capability
- Tape and reel packaging available
- Termination style: 3-sided wraparound termination or single termination flip chip standard; 5-sided wraparound termination available
- Internationally standardized sizes
- Suitable for solderable, epoxy bondable, or wire bondable applications
- Termination material: solder-coated nickel barrier or solder coated non-magnetic terminations standard; gold, palladium silver, platinum gold, platinum silver or platinum palladium gold terminations available
- Multiple styles, termination materials and configurations, allow wide design flexibility
- Epoxy bondable or wire bondable non-magnetic terminations available
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

STANDARD ELECTRICAL SPECIFICATIONS						
GLOBAL MODEL	CASE SIZE	POWER RATING P _{70 °C} W	MAXIMUM WORKING VOLTAGE ⁽¹⁾ V	RESISTANCE RANGE (2) Ω	TOLERANCE (3) ± %	TEMPERATURE COEFFICIENT ⁽⁴⁾ (-55 °C to +155 °C) ± ppm/°C
				2M to 100M	0.5	
CRHV1206	1206	0.30	1500	2M to 1G	1, 2, 5, 10, 20	100
				1.1G to 8G	2, 5, 10, 20	
				4M to 100M	0.5	
CRHV1210	1210	0.45	1750	4M to 1G	1, 2, 5, 10, 20	100
				1.1G to 10G	2, 5, 10, 20	
				6M to 100M	0.5	
00111/0040	2010	0.50	0000	6M to 1G	1, 2, 5, 10, 20	400
CRHV2010	2010	0.50	2000	1.1G to 10G	2, 5, 10, 20	100
				11G to 35G	5, 10, 20	
				10M to 100M	0.5	
00111/0540	0540	0.00	0500	10M to 1G	1, 2, 5, 10, 20	400
CRHV2510	2510	0.60	2500	1.1G to 10G	2, 5, 10, 20	100
				11G to 40G	5, 10, 20	
CRHV2512	0510	1.0	3000	12M to 100M	0.5	100
				12M to 1G	1, 2, 5, 10, 20	
	2512			1.1G to 10G	2, 5, 10, 20	
				11G to 50G	5, 10, 20	

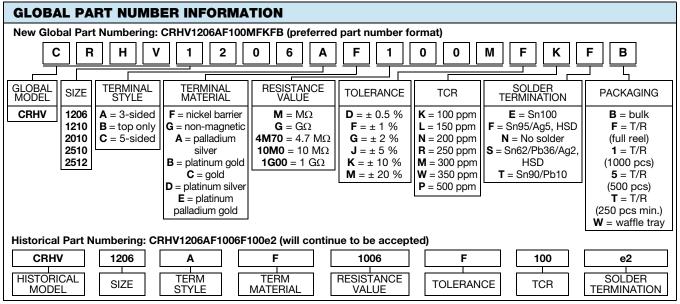
Notes

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- For non-standard sizes, lower values or higher power rating requirement, contact factory
- ⁽¹⁾ Continuous working voltage shall be $\sqrt{P \times R}$ or maximum working voltage, whichever is less
- (2) Resistance values below 1 GΩ are calibrated at 100 V_{DC}, and values of 1 GΩ and above are calibrated at 1000 V_{DC}. Calibration at other voltages available upon request
- (3) Contact factory for tighter tolerances
- (4) Reference only: not for all values specified. Consult factory for your size and value. The TC for "AA" option is typically 200 ppm

1 Document Number: 68002



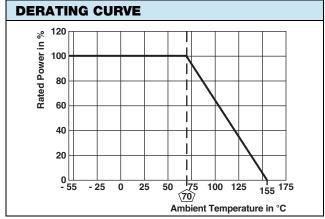


Note

For additional information on packaging, refer to the Surface Mount Resistor Packaging document (<u>www.vishay.com/doc?31543</u>)

MECHANICAL SPECIFICATIONS				
Resistive element	Ruthenium oxide			
Encapsulation	Glass			
Substrate	96 % alumina			
Termination	Solder-coated nickel barrier or solder coated non-magnetic terminations standard. Gold, palladium silver, platinum gold, platinum silver, platinum palladium gold terminations available.			
Solder finish	Pure tin or tin/lead solder alloys standard. Tin/silver or tin/lead/silver solder alloys available.			

ENVIRONMENTAL SPECIFICATIONS			
Operating temperature	-55 °C to +155 °C		
Life	Less than 0.5 % change when tested at full rated power		
Short time overload	Less than 0.5 % ΔR		

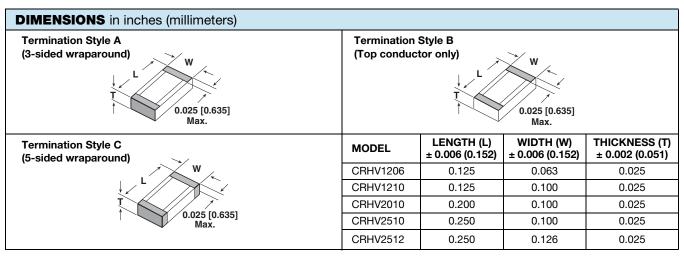


Note

 Reference only: Not for all values specified. Consult factory for your size and value

VOLTAGE COEFFICIENT OF RESISTANCE CHART				
SIZE	VALUE (Ω)	VCR (ppm/V)	FURTHER INSTRUCTIONS	
CRHV1206	2M to 199M	25	Values over 200M, consult factory	
CRHV1210	4M to 200M	25	Values over 200M, consult factory	
CRHV2010	6M to 99M	15	Values aver 10, consult factors	
ChHV2010	100M to 1G	20	Values over 1G, consult factory	
CRHV2510	10M to 99M	10	Values over 1G, consult factory	
CRHV2510	100M to 1G	15		
CRHV2512	12M to 999M	10	Values over 5G, consult factory	
CNEVZOIZ	1G to 5G	25		





TYPE	TERMINATION MATERIAL	TERMINATION STYLE	TERMINATION STYLE/ MATERIAL CODE	SOLDER TERMINATION CODE	
Solderable	Nickel barrier	3-sided (wraparound)	AF	F = 1 T (= t = 1 = 1 = 1 = 1)	
		Top only (flip chip)	BF	E or T (standard); F or S (optional) (3)	
		5-sided (wraparound)	CF	For 3 (optional)	
	Non-magnetic	3-sided (wraparound)	AG	E or T (standard);	
		Top only (flip chip)	BG	F or S (optional) (3)	
Francis la sur da la la /	Platinum palladium gold	3-sided (wraparound)	AE	N/	
Epoxy bondable/ solderable		Top only (flip chip)	BE	N (standard); F or S (optional) ⁽¹⁾	
Soluerable		5-sided (wraparound)	CE	i- or 3 (optional) (9	
14 5	Gold	3-sided (wraparound)	AC		
Wire bondable/ Epoxy bondable		Top only (flip chip)	BC	N	
Epoxy bondable		5-sided (wraparound)	CC		
		3-sided (wraparound)	AA		
	Palladium silver (2)	Top only (flip chip)	BA		
		5-sided (wraparound)	CA	1	
	Platinum gold	3-sided (wraparound)	AB		
Epoxy bondable		Top only (flip chip)	BB	N	
		5-sided (wraparound)	СВ		
		3-sided (wraparound)	AD]	
	Platinum silver	Top only (flip chip)	BD		
		5-sided (wraparound)	CD		

Notes

- (1) Use solder termination N for applications requiring epoxy bondable mounting, and solder terminations F or S for applications requiring solderable mounting
- (2) While not recommended, palladium silver terminations could be used for solderable applications when using a solder alloy containing silver. If the solder paste being used to solder the palladium silver terminated parts to the boards does not have a silver-based composition, then the silver in the terminations could begin to leach when it is exposed to liquidus non-silver-based solders, causing the potential for solderability and/or solder joint issues
- (3) Standard solder plating for the nickel barrier and non-magnetic parts is solder terminations E or T. Hot solder dipped terminations F or S are also available

PERFORMANCE				
TEST	CONDITIONS OF TEST	TEST RESULTS (TYPICAL TEST LOTS)		
Life	MIL-STD-202, method 108, 1000 h rated power at +70 °C	≤ ± 0.5 %		
High temperature exposure	MIL-STD-202, method 108	≤ ± 0.2 %		
Low temperature operation	MIL-PRF-55342, paragraph 4.8.5	≤ ± 0.05 %		
Resistance to bonding exposure	MIL-STD-202, methods 210	≤ ± 0.1 %		
Moisture resistance	MIL-PRF-55342, paragraph 4.8.9	≤ ± 0.06%		
Solder mounting integrity	MIL-PRF-55342, paragraph 4.8.13, 2 kg for 30 s	No evidence of mechanical damage		
Solderability	MIL-STD-202, method 208	95 % coverage		

Note

• This summary is based on testing done on values up to 2 $G\Omega$



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